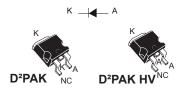
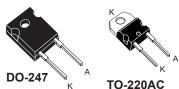


## Automotive turbo 2 ultrafast high voltage rectifier





#### **Features**



- · High junction temperature capability
- · Ultrafast with soft recovery behavior
- · Low reverse current
- · Low thermal resistance
- · Reduce switching and conduction losses
- PPAP capable
- D<sup>2</sup>PAK HV creepage distance (anode to cathode) = 5.38 mm min. (with top coating)
- V<sub>RRM</sub> guaranteed from -40 °C to 175 °C
- ECOPACK®2 compliant (DO-247, TO-220AC)

#### **Applications**

- · Output rectification
- PFC
- UPS
- Air conditioning
- Charging station

# Product status link

STTH30RQ06-Y

| Product                | Product summary   |  |  |  |  |
|------------------------|-------------------|--|--|--|--|
| I <sub>F(AV)</sub>     | 30 A              |  |  |  |  |
| V <sub>RRM</sub>       | 600 V             |  |  |  |  |
| V <sub>F</sub> (typ.)  | 1.45 V            |  |  |  |  |
| t <sub>rr</sub> (max.) | 30 ns             |  |  |  |  |
| Tj                     | -40 °C to +175 °C |  |  |  |  |

### **Description**

The STTH30RQ06-Y has been developed to be used in application requiring a high-voltage secondary rectification for LLC Full Bridge topology.

It is also suited for use in switching power supplies and automotive applications, industrial applications, as rectification, freewheeling and clamping diode.



## 1 Characteristics

Table 1. Absolute ratings (limiting values, at 25 °C, unless otherwise specified)

| Symbol              | Parameter  |                                   |  | Value       | Unit |
|---------------------|--|-----------------------------------|--|-------------|------|
| V <sub>RRM</sub>    | Repetitive peak reverse voltage                                    |                                   | $T_j = -40  ^{\circ}\text{C} \text{ to } +175  ^{\circ}\text{C}$ | 600         | V    |
| I <sub>F(RMS)</sub> | Forward rms current  |                                   |  | 50          | Α    |
| I <sub>F(AV)</sub>  | Average forward current $\delta$ = 0.5, square wave $T_C$ = 125 °C |                                   | 30   | Α           |      |
| leau                | Surge non repetitive forward current                               | t <sub>n</sub> = 10 ms sinusoidal | D²PAK, D²PAK HV  | 180         | Α    |
| I <sub>FSM</sub>    | Surge non repetitive forward current                               | tp = 10 ms sinusoidai             | TO-220AC, DO-247   | 200         |      |
| T <sub>stg</sub>    | Storage temperature range  |                                   |  | -65 to +175 | °C   |
| Tj                  | Operating junction temperature range                               |                                   |  | -40 to +175 | °C   |

**Table 2. Thermal parameters** 

| Symbol        | Parameter        | Max. value | Unit |
|---------------|------------------|------------|------|
| $R_{th(j-c)}$ | Junction to case | 0.7        | °C/W |

Table 3. Static electrical characteristics

| Symbol                        | Parameter  | Test conditions         |                                   | Min.                  | Тур. | Max. | Unit     |  |
|-------------------------------|--|-------------------------|-----------------------------------|-----------------------|------|------|----------|--|
| I <sub>R</sub> <sup>(1)</sup> | Deverse leakage surrent  | T <sub>j</sub> = 25 °C  | V <sub>R</sub> = V <sub>RRM</sub> | -                     |      | 40   |          |  |
| IR (7)                        | I <sub>R</sub> <sup>(1)</sup> Reverse leakage current  | T <sub>j</sub> = 150 °C | VR = VRRM                         | -                     | 80   | 800  | μA       |  |
|                               |  | T <sub>j</sub> = 25 °C  | 1 - 15 A                          | I <sub>F</sub> = 15 A | -    |      | 2.45     |  |
| V <sub>-</sub> (2)            | $V_{F} \stackrel{(2)}{=} Forward \ voltage \ drop$ $T_{j} = 150 \ ^{\circ}C$ $T_{j} = 25 \ ^{\circ}C$ $T_{j} = 150 \ ^{\circ}C$ $I_{F} = 30 \ A$ | -                       | 1.15                              | 1.45                  | v    |      |          |  |
| VF (=)                        |  | T <sub>j</sub> = 25 °C  | I- = 30 Δ                         | -                     |      | 2.95 | <b>v</b> |  |
|                               |  | T <sub>j</sub> = 150 °C | IF - 30 A                         | -                     | 1.45 | 1.85 |          |  |

<sup>1.</sup> Pulse test:  $t_p = 5$  ms,  $\delta < 2\%$ 

To evaluate the conduction losses, use the following equation:

$$P = 1.05 \text{ x } I_{F(AV)} + 0.026 \text{ x } I_{F}^{2} (RMS)$$

Table 4. Dynamic electrical characteristics

| Symbol          | Parameter  |                         | Test conditions   |   |     | Max. | Unit |
|-----------------|--|-------------------------|---|---|-----|------|------|
| +               | $t_{rr}$ Reverse recovery time $T_i = 25 ^{\circ}\text{C}$ |                         | I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A, I <sub>rr</sub> = 0.25 A          | - |     | 30   | no   |
| ι <sub>ττ</sub> | Reverse recovery time $T_j = 25^{\circ}$                   | 1, - 25 0               | $I_F = 1 \text{ A}, V_R = 30 \text{ V}, dI_F/dt = -50 \text{ A/}\mu\text{s}$    | - | 40  | 55   | ns   |
| I <sub>RM</sub> | Reverse recovery current                                   |                         |   | - | 8   | 11   | Α    |
| Q <sub>RR</sub> | Reverse recovery charge                                    | T <sub>j</sub> = 125 °C | $I_F = 30 \text{ A}, V_R = 400 \text{ V}, dI_F/dt = -200 \text{ A}/\mu\text{s}$ | - | 485 |      | nC   |
| t <sub>rr</sub> | Reverse recovery time                                      |                         |   | - | 95  |      | ns   |

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<sup>2.</sup> Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2%



For more information, please refer to the following application notes related to the power losses:

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses in a power diode

#### 1.1 Characteristics (curves)

Figure 1. Average forward power dissipation versus average forward current (square waveform)

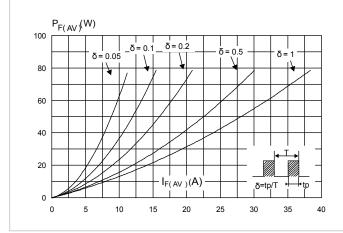


Figure 2. Average forward power dissipation versus average forward current (sinusoidal waveform)

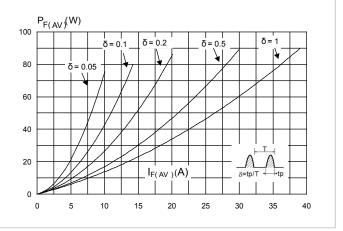


Figure 3. Forward voltage drop versus forward current (typical values)

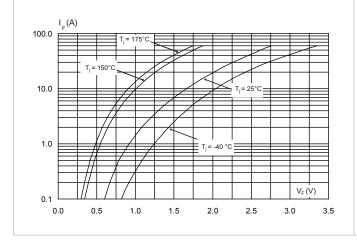
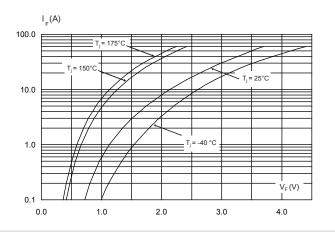


Figure 4. Forward voltage drop versus forward current (maximum values)



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Figure 5. Relative variation of thermal impedance junction to case versus pulse duration

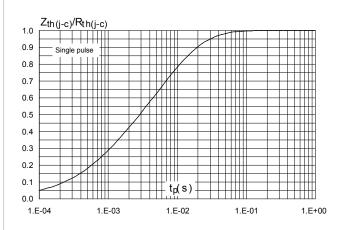


Figure 6. Peak reverse recovery current versus dl<sub>F</sub>/dt (typical values)

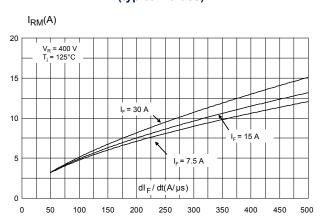


Figure 7. Reverse recovery time versus dl<sub>F</sub>/dt (typical values)

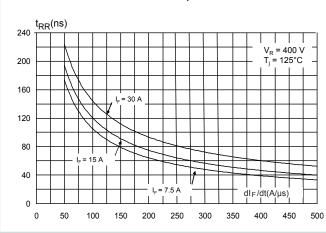


Figure 8. Reverse recovery charges versus dl<sub>F</sub>/dt (typical values)

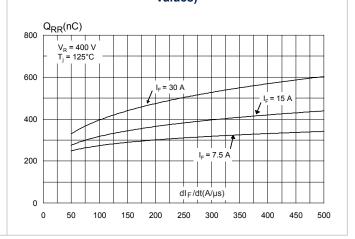


Figure 9. Reverse recovery softness factor versus dl<sub>F</sub>/dt (typical values)

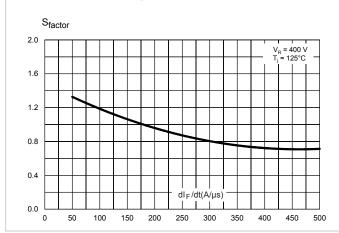
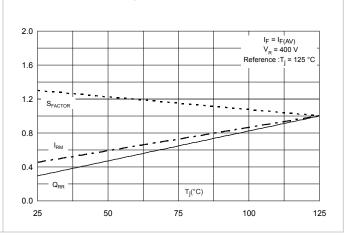


Figure 10. Relative variations of dynamic parameters versus junction temperature



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Figure 11. Junction capacitance versus reverse voltage applied (typical values)

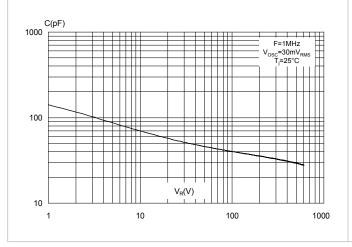


Figure 12. Thermal resistance junction to ambient versus copper surface under tab (typical values, epoxy printed board FR4, e<sub>Cu</sub> = 35 µm)(D²PAK and D²PAK HV)

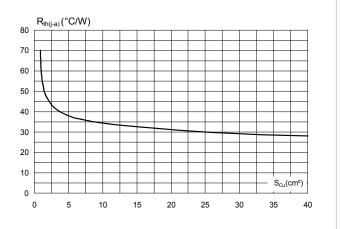


Figure 13. Relative variation of non-repetitive peak surge forward current versus pulse duration (sinusoidal waveform)

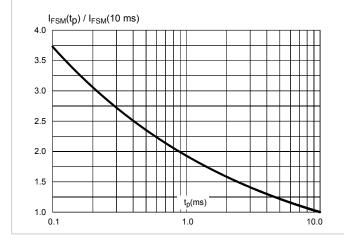
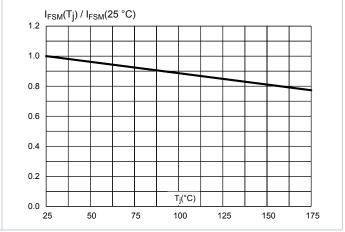


Figure 14. Relative variation of non-repetitive peak surge forward current versus initial junction temperature (sinusoidal waveform)



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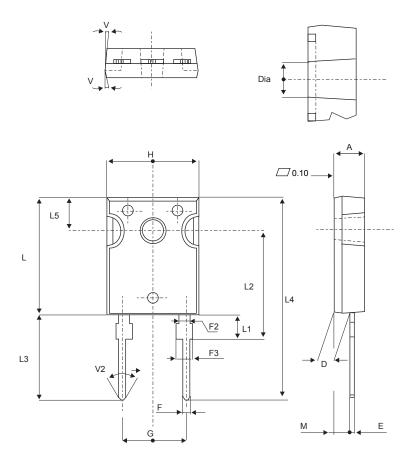
## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

### 2.1 DO-247 package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.8 N·m (DO-247)
- Maximum torque value: 1.0 N·m (DO-247)

Figure 15. DO-247 package outline



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Table 5. DO-247 package mechanical data

|      | Dimensions |           |            |       |  |
|------|------------|-----------|------------|-------|--|
| Ref. | Millim     | eters     | Inch       | es    |  |
|      | Min.       | Max.      | Min.       | Max.  |  |
| А    | 4.85       | 5.15      | 0.191      | 0.203 |  |
| D    | 2.20       | 2.60      | 0.086      | 0.102 |  |
| E    | 0.40       | 0.80      | 0.015      | 0.031 |  |
| F    | 1.00       | 1.40      | 0.039      | 0.055 |  |
| F2   | 2.00       | typ.      | 0.078      | typ.  |  |
| F3   | 2.00       | 2.40      | 0.078      | 0.094 |  |
| G    | 10.90      | typ.      | 0.429 typ. |       |  |
| Н    | 15.45      | 15.75     | 0.608      | 0.620 |  |
| L    | 19.85      | 20.15     | 0.781      | 0.793 |  |
| L1   | 3.70       | 4.30      | 0.145      | 0.169 |  |
| L2   | 18.50      | typ.      | 0.728 typ. |       |  |
| L3   | 14.20      | 14.80     | 0.559      | 0.582 |  |
| L4   | 34.60      | typ.      | 1.362 typ. |       |  |
| L5   | 5.50       | 5.50 typ. |            | typ.  |  |
| М    | 2.00       | 3.00      | 0.078      | 0.118 |  |
| V    | 5°         |           | 5°         |       |  |
| V2   | 60         | )°        | 60°        |       |  |
| Dia. | 3.55       | 3.65      | 0.139      | 0.143 |  |



#### D<sup>2</sup>PAK package information 2.2

- Epoxy meets UL94, V0.
- Cooling method: by conduction (C)

THERMAL PAD SEATING PLANE COPLANARITY 0.25 GAUGE PLANE V2\_

Figure 16. D<sup>2</sup>PAK package outline

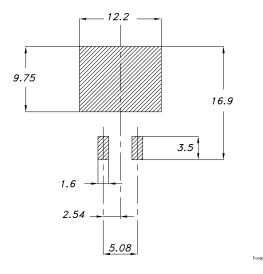
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Table 6. D<sup>2</sup>PAK package mechanical data

|      | Dimensions |             |       |       |                  |         |  |
|------|------------|-------------|-------|-------|------------------|---------|--|
| Ref. |            | Millimeters |       | Inche | s (for reference | e only) |  |
|      | Min.       | Тур.        | Max.  | Min.  | Тур.             | Max.    |  |
| А    | 4.40       |             | 4.60  | 0.173 |                  | 0.181   |  |
| A1   | 0.03       |             | 0.23  | 0.001 |                  | 0.009   |  |
| b    | 0.70       |             | 0.93  | 0.028 |                  | 0.037   |  |
| b2   | 1.14       |             | 1.70  | 0.045 |                  | 0.067   |  |
| С    | 0.45       |             | 0.60  | 0.018 |                  | 0.024   |  |
| c2   | 1.23       |             | 1.36  | 0.048 |                  | 0.053   |  |
| D    | 8.95       |             | 9.35  | 0.352 |                  | 0.368   |  |
| D1   | 7.50       | 7.75        | 8.00  | 0.295 | 0.305            | 0.315   |  |
| D2   | 1.10       | 1.30        | 1.50  | 0.043 | 0.051            | 0.060   |  |
| Е    | 10.00      |             | 10.40 | 0.394 |                  | 0.409   |  |
| E1   | 8.30       | 8.50        | 8.70  | 0.335 | 0.343            | 0.346   |  |
| E2   | 6.85       | 7.05        | 7.25  | 0.266 | 0.278            | 0.282   |  |
| е    |            | 2.54        |       |       | 0.100            |         |  |
| e1   | 4.88       |             | 5.28  | 0.190 |                  | 0.205   |  |
| Н    | 15.00      |             | 15.85 | 0.591 |                  | 0.624   |  |
| J1   | 2.49       |             | 2.69  | 0.097 |                  | 0.106   |  |
| L    | 2.29       |             | 2.79  | 0.090 |                  | 0.110   |  |
| L1   | 1.27       |             | 1.40  | 0.049 |                  | 0.055   |  |
| L2   | 1.30       |             | 1.75  | 0.050 |                  | 0.069   |  |
| R    |            | 0.40        |       |       | 0.015            |         |  |
| V2   | 0°         |             | 8°    | 0°    |                  | 8°      |  |

Figure 17. D<sup>2</sup>PAK recommended footprint (dimensions are in mm)



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## 2.3 TO-220AC package information

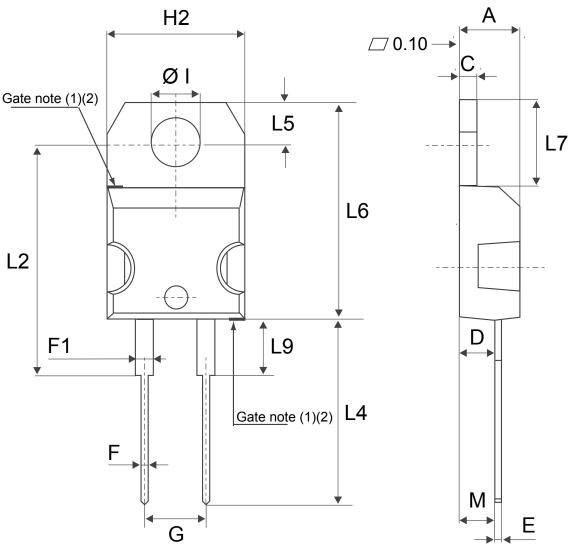
Epoxy meets UL 94,V0

• Cooling method: by conduction (C)

Recommended torque value: 0.55 N·m

Maximum torque value: 0.70 N⋅m

Figure 18. TO-220AC package outline



- (1) :Max resin gate protusion 0.5 mm
- (2) :Resin gate position is accepted in each of the two positions shown on the drawings or their symmetrical

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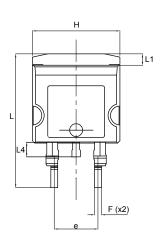
Table 7. TO-220AC package mechanical data

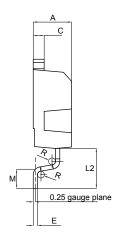
|      | Dimensions  |                 |                |               |  |
|------|-------------|-----------------|----------------|---------------|--|
| Ref. | Millimeters |                 | Inches (for re | ference only) |  |
|      | Min.        | Max.            | Min.           | Max.          |  |
| Α    | 4.40        | 4.60            | 0.173          | 0.181         |  |
| С    | 1.23        | 1.32            | 0.048          | 0.051         |  |
| D    | 2.40        | 2.72            | 0.094          | 0.107         |  |
| E    | 0.49        | 0.70            | 0.019          | 0.027         |  |
| F    | 0.61        | 0.61 0.88 0.024 |                | 0.034         |  |
| F1   | 1.14        | 1.70 0.044      |                | 0.066         |  |
| G    | 4.95        | 5.15            | 0.194          | 0.202         |  |
| H2   | 10.00       | 10.40           | 0.393          | 0.409         |  |
| L2   | 16.4        | 0 typ.          | 0.645 typ.     |               |  |
| L4   | 13.00       | 14.00           | 0.511          | 0.551         |  |
| L5   | 2.65        | 2.95            | 0.104          | 0.116         |  |
| L6   | 15.25       | 15.75           | 0.600          | 0.620         |  |
| L7   | 6.20        | 6.60            | 0.244          | 0.259         |  |
| L9   | 3.50        | 3.93 0.137      |                | 0.154         |  |
| M    | 2.60        | typ.            | 0.102          | typ.          |  |
| Diam | 3.75        | 3.85            | 0.147          | 0.151         |  |

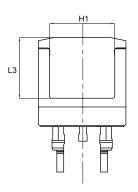


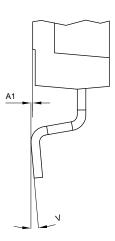
## 2.4 D<sup>2</sup>PAK HV package information

Figure 19. D<sup>2</sup>PAK high voltage package outline









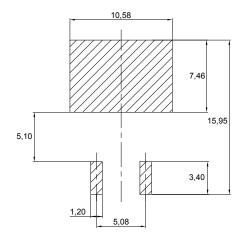
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Table 8. D<sup>2</sup>PAK high voltage package mechanical data

| Def. | Dimensions |      |       |  |  |  |
|------|------------|------|-------|--|--|--|
| Ref. | Min.       | Тур. | Max.  |  |  |  |
| А    | 4.30       |      | 4.70  |  |  |  |
| A1   | 0.03       |      | 0.20  |  |  |  |
| С    | 1.17       |      | 1.37  |  |  |  |
| е    | 4.98       |      | 5.18  |  |  |  |
| E    | 0.50       |      | 0.90  |  |  |  |
| F    | 0.78       |      | 0.85  |  |  |  |
| Н    | 10.00      |      | 10.40 |  |  |  |
| H1   | 7.40       |      | 7.80  |  |  |  |
| L    | 15.30      |      | 15.80 |  |  |  |
| L1   | 1.27       |      | 1.40  |  |  |  |
| L2   | 4.93       |      | 5.23  |  |  |  |
| L3   | 6.85       |      | 7.25  |  |  |  |
| L4   | 1.5        |      | 1.7   |  |  |  |
| M    | 2.6        |      | 2.9   |  |  |  |
| R    | 0.20       |      | 0.60  |  |  |  |
| V    | 0°         |      | 8°    |  |  |  |

Figure 20. D<sup>2</sup>PAK High Voltage footprint in mm



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#### 2.4.1 Creepage distance between anode and cathode

Table 9. Creepage distance between anode and cathode

| Symbol             | Parameter  |          | Value | Unit |
|--------------------|--|----------|-------|------|
| Cd <sub>A-K1</sub> | Minimum creepage distance between A and K1 (with top coating)    |          | 5.38  | mm   |
| Cd <sub>A-K2</sub> | Minimum creepage distance between A and K2 (without top coating) | D²PAK HV |       | mm   |

Note: D<sup>2</sup>PAK HV creepage distance (anode to cathode) = 5.38 mm min. (refer to IEC 60664-1)

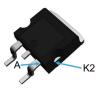
Figure 21. Creepage with top coating

Creepage

Minimum distance between A & K1 = 5.38 mm (with top coating)

Figure 22. Creepage without top coating

Creepage



Minimum distance between A & K2 = 3.48 mm (without top coating)

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# **3** Ordering information

Table 10. Ordering information

| Order code       | Marking      | Package  | Weight | Base qty. | Delivery mode |
|------------------|--------------|----------|--------|-----------|---------------|
| STTH30RQ06GY-TR  | STTH30RQ06GY | D²PAK    | 1.48 g | 1000      | Tape and reel |
| STTH30RQ06DY     | STTH30RQ06DY | TO-220AC | 1.86 g | 50        | Tube          |
| STTH30RQ06WY     | STTH30RQ06WY | DO-247   | 4.40 g | 30        | Tube          |
| STTH30RQ06G2Y-TR | TH30RQ06G2Y  | D²PAK HV | 1.48 g | 1000      | Tape and reel |



## **Revision history**

**Table 11. Document revision history** 

| Date        | Revision | Changes  |
|-------------|----------|--|
| 12-Jun-2017 | 1        | Initial release.   |
| 09-Oct-2018 | 2        | Added D²PAK HV package.  |
| 20-Nov-2018 | 3        | Updated Features and Table 9. Creepage distance between anode and cathode.  added Figure 22. Creepage without top coating. |

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